

Atmel LED Drivers

MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

Datasheet Brief



Atmel LED Drivers-MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

General Description

The Atmel LED Drivers-MSL3163 and MSL3164 compact, high-power LED string drivers use internal current control MOSFETs to sink up to 100mA per string, with current accuracy and matching better than 3%. The MSL3163/4 drive 16 parallel strings of ten white LEDs each, for a total of 160 white LEDs per device. Sixteen interconnected devices control up to 2560 white LEDs.

The MSL3163/4 adaptively controls the DC-DC converters that power the LED strings, using Atmel's Adaptive SourcePower technology. These Efficiency Optimizers minimize power use while maintaining LED current accuracy.

The MSL3164 features a 20 MHz SPI serial interface, and the MSL3163 offers a 1 MHz I²C serial interface. Both interfaces support video frame-by-frame LED string intensity control for up to 16 interconnected devices to allow active area dimming. The devices include an advanced PWM engine that easily synchronizes to a video signal, and per-string phase adjustment to reduce unwanted LCD artifacts such as motion blur. Additionally, an on-chip E²PROM allows the power-up defaults to be customized through the serial interface.

A unique combination of peak current control and pulse width management offer simple full screen brightness control, versatile area dimming and a consistent white point. One external resistor provides the global peak reference current for all LED strings, and global peak current fine-tuning is available through an 8-bit register. Global string drive pulse width is adjusted with an 8-bit global intensity register, and individual string pulse width is modulated with 12-bit registers.

The MSL3163/4 feature fault monitoring of open circuit, short circuit, loss of video sync and over temperature conditions, and provides a fault output to notify the system controller. Detailed fault status and control are available through the serial interface.

The MSL3163/4 are offered in a 6 x 6 x 0.75mm, 40-pin TQFN package and operate over the -40°C to 85°C temperature range.

Applications

Long Life, Efficient LED Backlighting For:

- Televisions and Desktop Monitors
- Medical and Industrial Instrumentation
- Automotive Audio-visual Displays

Channel Signs

Architectural Lighting

Ordering Information

| 16-CHANNEL LED STRING DRIVERS | | |
|-------------------------------|----------------------------|-----------------------------|
| PART | INTERFACE | PACKAGE |
| MSL3163BT | I ² C interface | 40 pin, 6 x 6 x 0.75mm TQFN |
| MSL3164BT | SPI interface | 40 pin, 6 x 6 x 0.75mm TQFN |

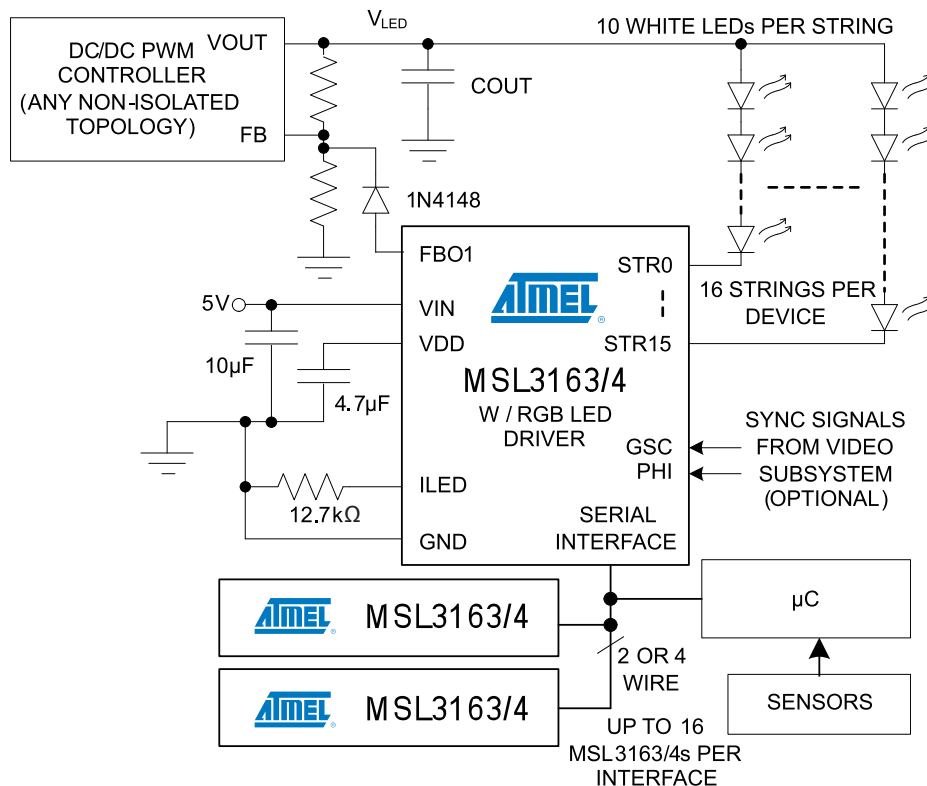
Atmel LED Drivers-MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

Key Features

- 12-bit PWM String Dimming Operates at 240Hz
- Fast Serial Interfaces Support up to 16 Devices per Bus:
 - MSL3164 20 MHz SPI
 - MSL3163 1 MHz I²C
- 8-bit Adaptive Power Correction Maximizes Efficiency of up to Three String Power Supplies
- Drives 16 Parallel LED Strings of 10 White LEDs Each for up to 2560 White LEDs per Serial Bus
- Supports Adaptive, Real-time Area Dimming for Highest Dynamic Range LCD TVs and Monitors
- Programmable String Phase Reduces Motion Blur
- Global Intensity Control via Serial Interface
- 100mA Peak, 60mA Average LED String Current
- Single Resistor Sets Peak Current for all LED Strings
- ±3% Current Accuracy and Current Balance
- Video Frame (VSYNC) and Line (HSYNC) Sync Inputs
- Sync Loss Detectors Optionally Disable LED Strings
- Multiple MSL3163/4s Share String Power Supplies and Automatically Negotiate the Optimum Supply Voltage
- E²PROM Allows Customized Power-On Defaults
- Less Than 1µA LED String Off-Leakage Current
- String Open Circuit and LED Short Circuit Fault Detection
- Individual Fault Detection Enable for Each String
- Over-temperature Shutoff Protection
- Broadcast Write Simplifies Configuration
- -40°C To +85°C Operating Temperature Range

Application Circuit





Package Pin-out

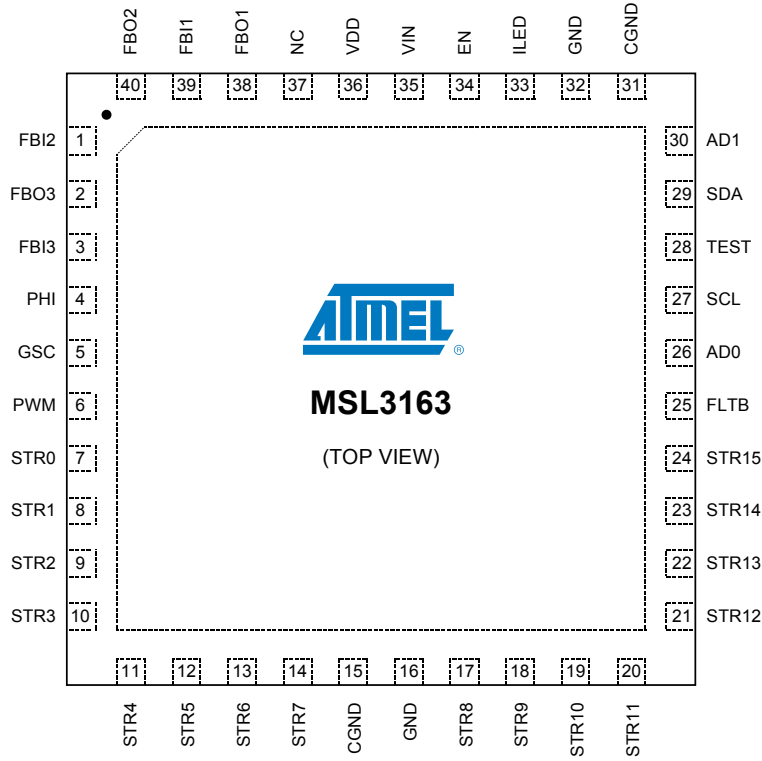


Figure 1. Atmel LED Driver-MSL3163 Pinout 40 Pin TQFN

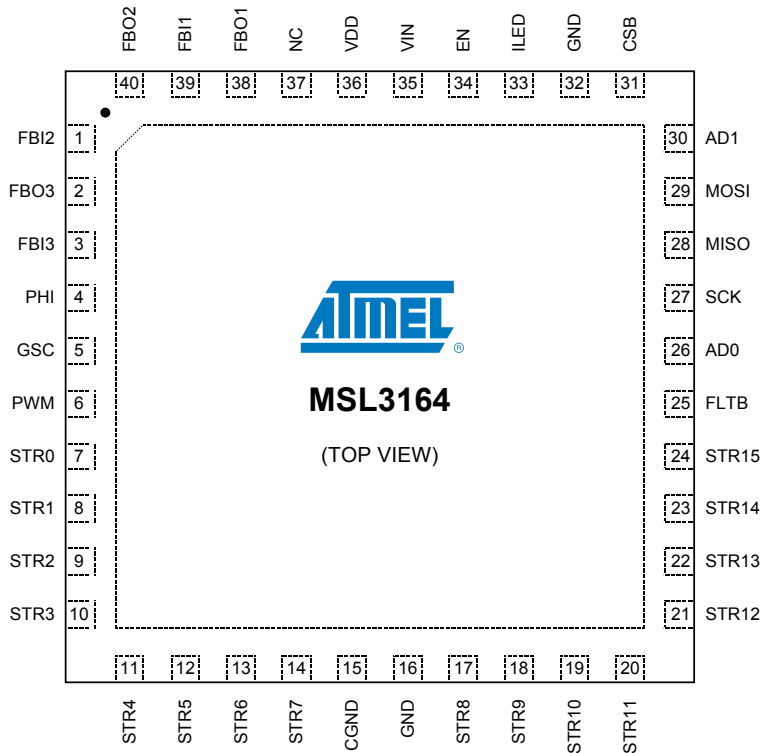


Figure 2. Atmel LED Driver-MSL3164 Pinout 40 Pin TQFN

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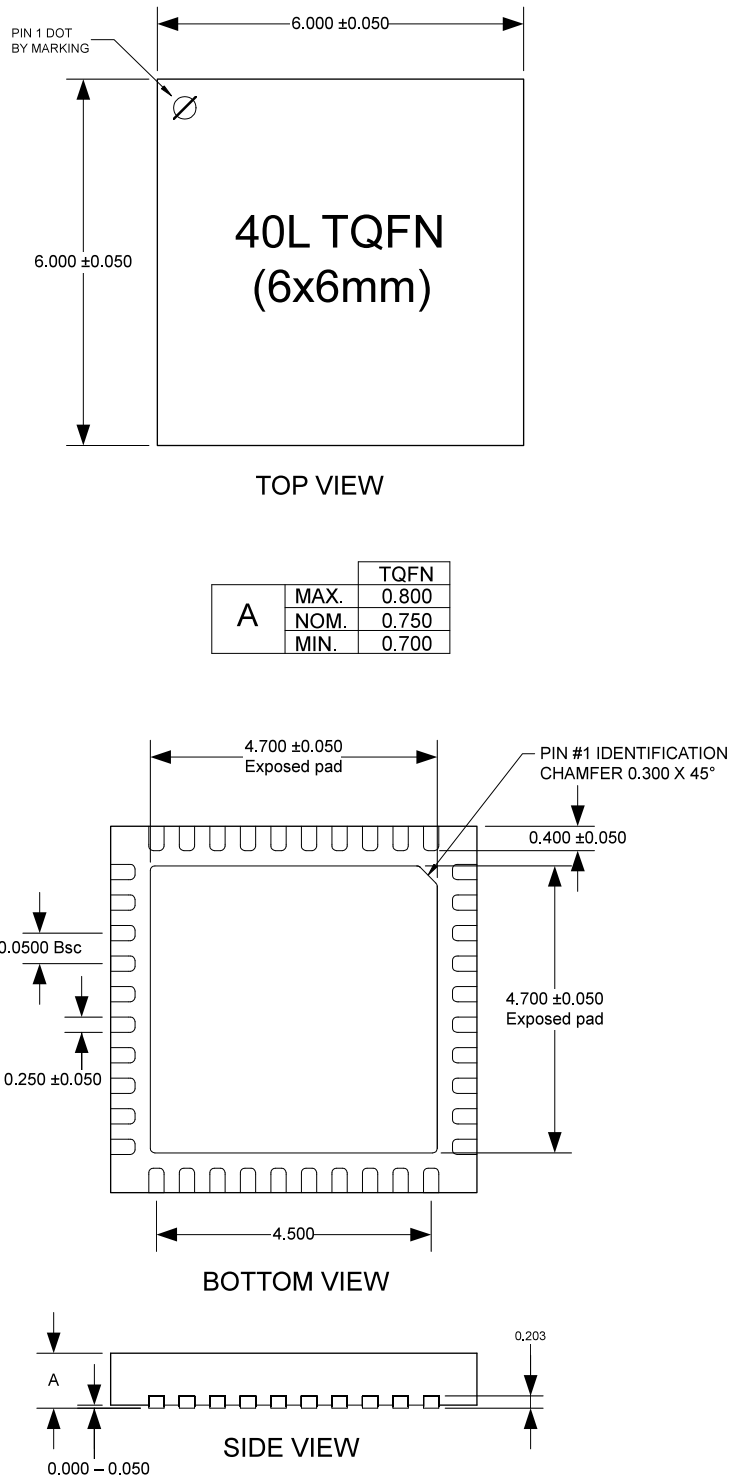


Figure 3. Package Dimensions: 40 Pin 6mm x 6mm x 0.75mm TQFN (0.5mm pin pitch) with exposed pad



Package Pin Description

Table 1. Pin Assignments

| PIN | PIN NAME | | PIN DESCRIPTION |
|-----------------------|-----------------------|-----------------------|--|
| | MSL3163 | MSL3164 | |
| 1 | FBI2 | FBI2 | Efficiency Optimizer input 2 Connect FBI2 to FBO2 of the next device when chaining devices (Figure 7). If unused connect FBI2 to GND. |
| 2 | FBO3 | FBO3 | Efficiency Optimizer output 3 Connect FBO3 to the third power supply's feedback node or to FBI3 of the previous device when chaining devices (Figure 7). If unused connect FBO3 to GND. |
| 3 | FBI3 | FBI3 | Efficiency Optimizer input 3 Connect FBI3 to FBO3 of the next device when chaining devices (Figure 7). If unused connect FBI3 to GND. |
| 4 | PHI | PHI | Phase synchronization input Drive PHI with an external signal from 40Hz to 10kHz to synchronize the MSL3163/4 clock. PHI is typically the VSYNC signal input. |
| 5 | GSC | GSC | Gate shift clock input Drive GSC with the gate shift clock of the video signal, from 0 to 10MHz. GSC is typically the HSYNC signal input. |
| 6 | PWM | PWM | PWM input PWM allows direct external control of the brightness of all LED strings. The PWM input may also be used as a gate signal for the output of the PWM. Drive PWM with a pulse-width modulated signal with duty ratio ranging from 0% to 100% and frequency up to 5kHz. When not configured for use as an input PWM is high-impedance. |
| 7 - 14, 17 - 24 | STR0 thru STR15 | STR0 thru STR15 | LED string current sink outputs Connect the cathode of the n'th strings bottom LEDs to STRn. Connect unused STRn outputs to GND. |
| 15 | CGND | CGND | Connect to ground Connect CGND to GND and to EP with short, wide traces. |
| 16, 32 | GND | GND | Signal ground Connect all GNDs to system ground and to EP with short, wide traces. |
| 25 | FLT B | FLT B | Fault indication output (active low) Open drain output FLT B sinks current to GND whenever a fault condition is verified. Toggle EN low or read the fault registers to clear FLT B. Once cleared, FLT B reasserts if the fault conditions persist. |
| 26, 30 | AD0, AD1 | AD0, AD1 | Slave ID selection inputs Connect AD1 and AD0 to GND through resistors to set the device address for the serial interface. |
| 27 | SCL | SCK | MSL3163: I²C serial clock input SCL is the clock input for the I ² C serial interface. |
| | | | MSL3164: SPI serial shift clock SCK is the clock input for the SPI interface. |
| 28 | TEST | MISO | MSL3163: factory test I/O Factory test. Make no electrical connection to TEST. |
| | | | MSL3164: Master input slave output MISO is the SPI serial data output. |
| 29 | SDA | MOSI | MSL3163: I²C serial data I/O SDA is the data I/O for the I ² C serial interface. |
| | | | MSL3164: Master input slave output MOSI is the SPI serial data input. |
| 31 | GND | CSB | MSL3163: ground. Connect GND to system ground and to EP with short, wide traces. |
| | | | MSL3164: chip select (active low) CSB is the chip select input for SPI transactions. CSB is active low. |
| 33 | ILED | ILED | Maximum LED string current setting input Connect a resistor from ILED to GND to set the full-scale LED string current for all strings using $I_{STRING} = 762 / R_{ILED}$. For example, connect a 12.7kΩ resistor to GND to set a 60mA maximum sink current through each LED string. |
| 34 | EN | EN | Enable input (Active high) Drive EN high to turn on the MSL3163/4, drive EN low to turn off the MSL3163/4. For automatic startup connect EN to VIN. When EN is low the entire device, including the serial interface, is turned off. Driving EN high initiates a boot load of the E ² PROM data into the control registers, simulating a cold start-up. |
| 35 | VIN | VIN | Supply voltage input Connect a 5V supply to VIN. Bypass VIN to GND with a 10μF ceramic capacitor placed close to VIN. |

Atmel LED Drivers–MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

| PIN | PIN NAME | | PIN DESCRIPTION |
|-----|----------|---------|---|
| | MSL3163 | MSL3164 | |
| 36 | VDD | VDD | 2.5V internal LDO regulator output VDD powers internal logic. Bypass VDD to GND with a 4.7μF ceramic capacitor placed close to VDD. |
| 37 | NC | NC | No connect Leave NC unconnected. |
| 38 | FBO1 | FBO1 | Efficiency Optimizer output 1 Connect FBO1 to the first power supply's feedback node or to FBI1 of the previous device when chaining devices (Figure 7). If unused connect FBO1 to GND. |
| 39 | FBI1 | FBI1 | Efficiency Optimizer input 1 Connect FBI1 to FBO1 of the next device when chaining devices (Figure 7). If unused connect FBI1 to GND. |
| 40 | FBO2 | FBO2 | Efficiency Optimizer output 2 Connect FBO2 to the second power supply's feedback node or to FBI2 of the previous device when chaining devices (Figure 7). If unused connect FBO2 to GND. |
| EP | EP | EP | Exposed pad, power ground EP is the path that the string currents take to ground. EP also provides thermal relief for the die. Provide large traces from EP back to the string power supplies. Also connect EP to system ground, and to GND using short, wide traces. |

Absolute Maximum Ratings

Voltage (With Respect to GND, CGND = EP = GND)

| | |
|---|-----------------------|
| VIN, EN | -0.3V to +6V |
| VDD | -0.3V to +2.75V |
| MSL3163: SDA, SCL | -0.3V to +6V |
| MSL3164: MISO, MOSI, CSB, SCK | -0.3V to (VIN + 0.3V) |
| FLTB | -0.3V to +6V |
| ILED, AD0, AD1 | -0.3V to (VDD + 0.3V) |
| PHI, GSC, PWM, FBO1, FBO2, FBO3, FBI1, FBI2, FBI3 | -0.3V to (VIN + 0.3V) |
| STR0 thru STR15 | -0.3V to +40V |
| CGND | -0.3V to +0.3V |

Current (Into Pin)

| | |
|-----------------|---------|
| VIN | 50mA |
| EP | -1700mA |
| STR0 thru STR15 | 105mA |
| All other pins | 20mA |

Continuous Power Dissipation

| | |
|---|-----------------|
| 40-Pin 6mm x 6mm QFN (derate 37mW/°C above T _A = +70°C) | 2963mW |
| Ambient Operating Temperature Range T _A = T _{MIN} to T _{MAX} | -40°C to +85°C |
| Junction Temperature | +125°C |
| Storage Temperature Range | -65°C to +125°C |
| Lead Soldering Temperature, 10s | +300°C |



Electrical Characteristics

(Typical Application Circuit, VIN = 5V, TA = TMIN to TMAX, unless otherwise noted. Typical values are at VIN = 5V, TA = +25°C).

| PARAMETER | SYMBOL | CONDITIONS AND NOTES | MIN | TYP | MAX | UNIT |
|---|--------------------|---|-----------|-------|-----------|-------|
| DC ELECTRICAL CHARACTERISTICS | | | | | | |
| VIN Operating Supply Voltage | VIN | | 4.75 | 5 | 5.5 | V |
| VIN Operating Supply Current | I _{VIN} | EN = VIN, SLEEP = 0, R _{I_{LED}} = 12.7kΩ, PHI = 240Hz, GSC = 983.04kHz, POWERCTRL = 0x4F, ISTR = 0xFF, OSCCTRL = 0x04, GSCINTEN = 0, PHIINTEN = 0, STRnEN = 1 | | 18 | 28 | mA |
| | | | | 24 | 35 | |
| VIN Shutdown Supply Current | I _{SHDN} | EN = GND, SDA, SCL, AD0, AD1, PWM, PHI and GSC = GND | | 10 | | μA |
| VIN Sleep Current | I _{SLEEP} | EN = 1, SLEEP = 1, SDA, SCL, AD0, AD1, PWM, PHI and GSC = GND or VDD | | 1.5 | | mA |
| VDD Regulation Voltage | VDD | | 2.4 | 2.5 | 2.6 | V |
| Input High Voltage: SDA, SCL, PWM, PHI, GSC, MOSI, CSB | V _{IH} | | 0.7 x VDD | | | V |
| Input Low Voltage: SDA, SCL, PWM, PHI, GSC, MOSI, CSB | V _{IL} | | | | 0.3 x VDD | V |
| Input High Voltage: EN | | | 1.22 | | | V |
| Input Low Voltage: EN | | | | | 0.8 | V |
| Output High Voltage: PHI, GSC, MISO | V _{OH} | I _{SOURCE} = 5mA | VIN – 0.4 | | | V |
| Output Low Voltage: PHI, GSC, SDA, MISO, FLTB | V _{OL} | I _{SINK} = 5mA | | | 0.4 | V |
| I _{LED} Regulation Voltage | | R _{I_{LED}} = 12.7kΩ | | 350 | | mV |
| FBI Feedback Input Current | | | 0 | | 365 | μA |
| FBO Feedback Output Current Range | | V _{FBO} ≤ VIN – 0.5V | 0 | | 365 | μA |
| FBO Feedback Output Current Step Size | | | | 1.1 | | μA |
| FBI Input Disable Threshold | | | | | 50 | mV |
| STR0 thru STR15 Sink Current | | R _{I_{LED}} = 12.7kΩ, ISTR = 0xFF, V _{STRn} = 1V | 55 | 60 | 67 | mA |
| STR0 thru STR15 Sink Current Maximum | | R _{I_{LED}} = 7.68kΩ, ISTR = 0xFF (Note 1) | | 100 | | mA |
| STR0 thru STR15 Current Load Regulation | | R _{I_{LED}} = 12.7kΩ; ISTR = 0xFF, FLDBKEN = 0, V _{STRn} = 1V to 5V | | 0.033 | | %/V |
| STR0 thru STR15 Current Matching | | R _{I_{LED}} = 12.7kΩ, ISTR = 0x7F, V _{STRn} = 1V | -5 | | 5 | % |
| STR0 thru STR15 Minimum Headroom | V _{STR} | R _{I_{LED}} = 12.7kΩ; ISTR = 0xFF | | 0.5 | | V |
| STR0 thru STR15 Short Circuit Fault Detection Threshold | SC _{REF} | | | 3.5 | | V |
| STR0 thru STR15 Current Slew Rate | | Current rising (Note 2) | | 608 | | mA/μs |
| | | Current falling (Note 2) | | 10868 | | |
| Thermal Shutdown Temperature | | (Note 2) | | 135 | | °C |

Atmel LED Drivers-MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

| PARAMETER | SYMBOL | CONDITIONS AND NOTES | MIN | TYP | MAX | UNIT |
|--------------------------------------|-----------|----------------------|-------|-------|-------|------------|
| AC ELECTRICAL CHARACTERISTICS | | | | | | |
| OSC Frequency | f_{OSC} | OSCCTRL = 0x04 | 18.15 | 20.00 | 21.88 | MHz |
| PHI Frequency | f_{PHI} | | 0.04 | | 10 | kHz |
| PHI Lock | | | | 4 | | PHI cycles |
| GSC Frequency | f_{GSC} | | 0 | | 10 | MHz |
| PWM Frequency | f_{PWM} | | | | 50 | kHz |
| PWM Duty Cycle | | | 0 | | 100 | % |

| PARAMETER | SYMBOL | CONDITIONS AND NOTES | MIN | TYP | MAX | UNIT |
|---|---------------|--|---------------------|-----|------|---------------|
| I²C TIMING CHARACTERISTICS, MSL3163 | | | | | | |
| SCL Clock Frequency | $1/t_{SCL}$ | Bus timeout disabled (Note 3) | 0 | | 1 | MHz |
| Bus Timeout Period | $t_{timeout}$ | OSCCTRL = 0x04 | | 30 | | ms |
| | | $f_{OSC} = 16\text{MHz to }23\text{MHz}$ | 600,000 / f_{OSC} | | | s |
| STOP to START Condition Bus Free Time | t_{BUF} | | 0.5 | | | μs |
| Repeated START condition Hold Time | $t_{HD:STA}$ | | 0.26 | | | μs |
| Repeated START condition Setup Time | $t_{SU:STA}$ | | 0.26 | | | μs |
| STOP Condition Setup Time | $t_{SU:STOP}$ | | 0.26 | | | μs |
| SDA Data Hold Time | $t_{HD:DAT}$ | | 50 | | | ns |
| SDA Data Valid Acknowledge Time | $t_{VD:ACK}$ | (Note 4) | 0.05 | | 0.45 | μs |
| SDA Data Valid Time | $t_{VD:DAT}$ | (Note 5) | 0.05 | | 0.45 | μs |
| SDA Data Set-Up Time | $t_{SU:DAT}$ | | 100 | | | ns |
| SCL Clock Low Period | t_{LOW} | | 0.5 | | | μs |
| SCL Clock High Period | t_{HIGH} | | 0.26 | | | μs |
| SDA, SCL Fall Time | t_f | (Note 6) (Note 7) | | | 120 | ns |
| SDA, SCL Rise Time | t_r | | | | 120 | ns |
| SDA, SCL Input Suppression Filter Period | t_{SP} | (Note 8) | | 50 | | ns |

| PARAMETER | SYMBOL | CONDITIONS AND NOTES | MIN | TYP | MAX | UNIT |
|--|-------------------|----------------------|-----|-----|-----|------|
| SPI TIMING CHARACTERISTICS, MSL3164 | | | | | | |
| SCK Frequency | | | | | 20 | MHz |
| CSB Falling Edge to SCK Rising Edge Setup Time | $t_{CSB:SCK(SU)}$ | | 100 | | | ns |



| PARAMETER | SYMBOL | CONDITIONS AND NOTES | MIN | TYP | MAX | UNIT |
|--|----------------------------|----------------------|-----|-----|-----|------|
| SCK Falling Edge to CSB Rising Edge Setup Time | $t_{\text{SCK:CSB(SU)}}$ | | 50 | | | ns |
| MOSI to Falling Edge of SCK Setup Time | $t_{\text{MOSI(SU)}}$ | | 16 | | | ns |
| SCK Falling Edge to MOSI Setup Time | $t_{\text{MOSI(HOLD)}}$ | | 20 | | | ns |
| MOSI, CSB, SCK Signal Rise Time | $t_{\text{R(SPI)}}$ | | | 5.0 | | ns |
| MOSI, CSB, SCK Signal Fall Time | $t_{\text{F(SPI)}}$ | | | 5.0 | | ns |
| CSB Falling Edge to MISO Data Valid | $t_{\text{CSB:MISO(DV)}}$ | | | | 50 | ns |
| CSB Rising Edge to MISO High Impedance | $t_{\text{CSB:MISO(HIZ)}}$ | | | | 50 | ns |
| SCK Rising Edge to MISO Data Valid | t_{VALID} | | | 25 | 80 | ns |

Note 1. Subject to thermal dissipation characteristics of the device

Note 2. Guaranteed by design, not production tested.

Note 3. Minimum SCL clock frequency is limited by the bus timeout feature, which resets the serial bus interface if either SDA or SCL is held low for t_{timeout} . Disable bus timeout via the Power Control register 0x02[6].

Note 4. t_{VDACK} = SCL LOW to SDA (out) LOW acknowledge time.

Note 5. t_{VDDAT} = minimum SDA output data-valid time following SCL LOW transition.

Note 6. A master device must internally provide an SDA hold time of at least 300ns to ensure an SCL low state.

Note 7. The maximum SDA and SCL rise times is 300ns. The maximum SDA fall time is 250ns. This allows series protection resistors to be connected between SDA and SCL inputs and the SDA/SCL bus lines without exceeding the maximum allowable rise time.

Note 8. MSL3163/4 includes input filters on SDA, SCL, AD0 and AD1 inputs that suppress noise less than 50ns.

Atmel LED Drivers-MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

Block Diagram

The block diagram for the Atmel LED Drivers-MSL3163/4 is shown in Figure 4.

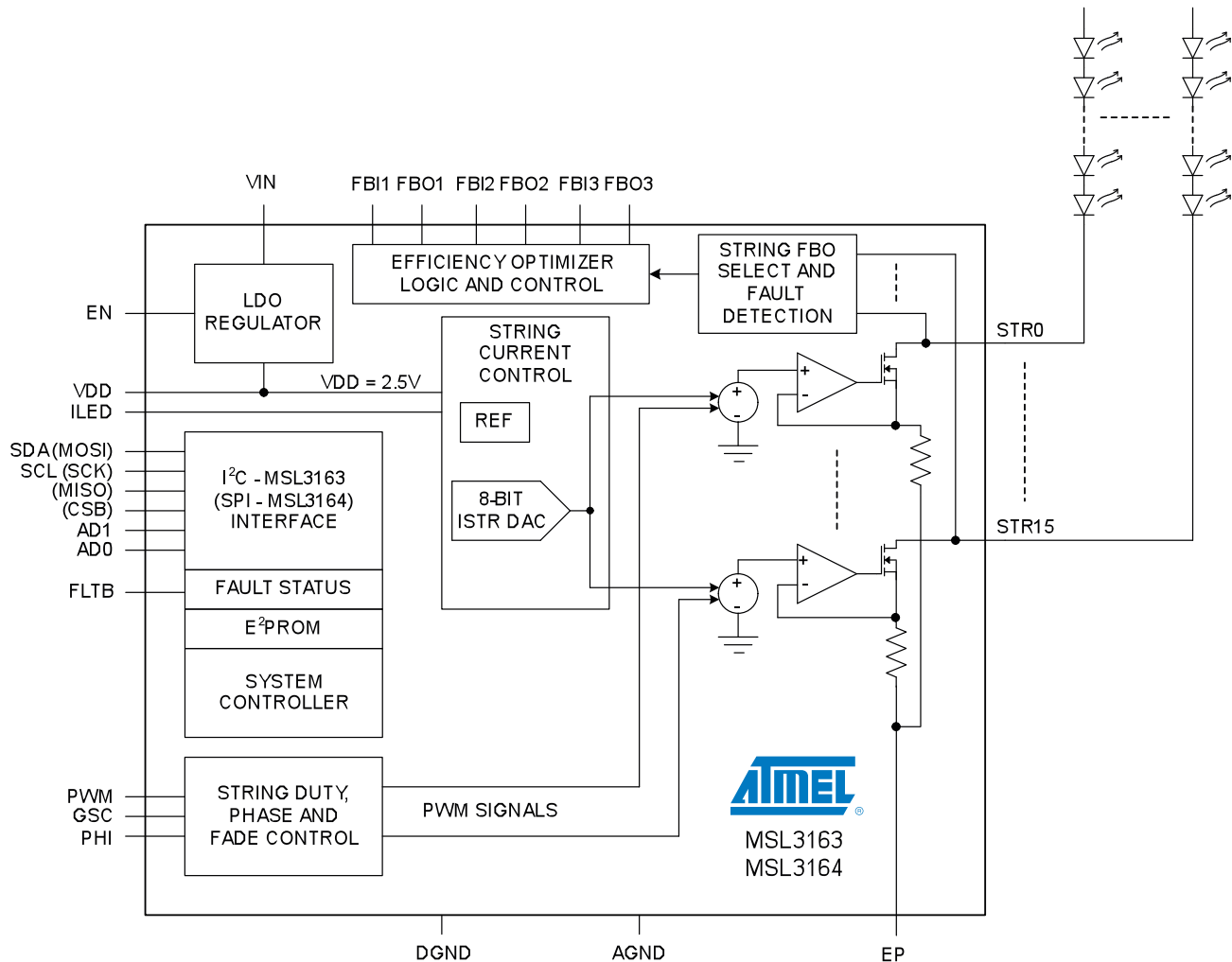


Figure 4. Atmel LED Drivers-MSL3163/4 Block Diagram

Typical Application Circuit

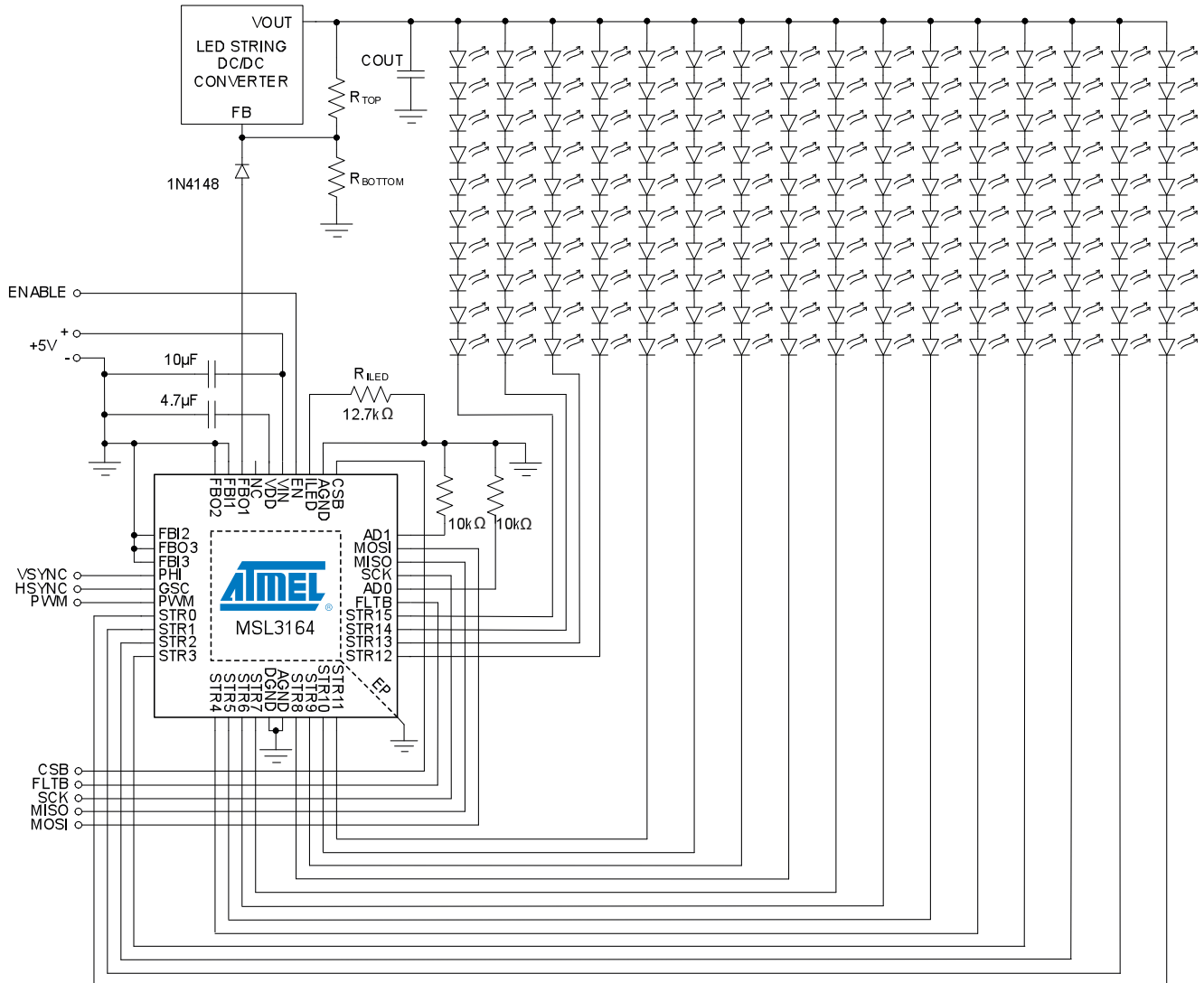


Figure 5. Atmel LED Driver-MSL3164 Driving 160 White LEDs in 16 Strings at 60mA Per String.

Atmel LED Drivers–MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

Detailed Description

The MSL3163 and MSL3164 are highly integrated, flexible multi-string LED drivers with power supply control to maximize system efficiency. The drivers easily connect to a video subsystem. Although optional, this offers a simple architecture for use in LCD TV backlight applications. Up to 16 drivers easily connect together to drive large numbers of LED strings in a system. The drivers provide multiple methods of controlling LED brightness, through both peak current control and through pulse width control of the string drive signals. Peak current control offers excellent color consistency, while pulse width control allows brightness management. An on-chip E²PROM holds all the default control register values. At power-up the data in the E²PROM automatically copy directly to the control registers, setting up the device for operation.

The devices interface to a μ C via I²C (MSL3163) or SPI (MSL3164). The robust 1MHz I²C interface supports up to 16 devices on the bus. The 20MHz bus addressable SPI interface supports up to 16 devices per Chip Select line. While typically the LED drive PWM signal is internally generated, both drivers also accept an external direct-drive PWM signal and offer optional string drive phase spreading. With direct-drive PWM, a Pulse Width Modulated signal applied to the PWM input sets the PWM duty and the frequency of the LEDs drive signal. With phase spreading enabled, a progressive 1/16 PWM-frame time delay per string helps reduce both the transient load on the LED power supplies, and the power supply input capacitor size requirements.

The PWM frequency of the drivers is either synchronized to an external signal applied to PHI, or generated from the internal oscillator for stand-alone applications. Typically the VSYNC signal from the video system is used for the PHI input. The on-time of each string is individually programmed via the device registers, providing a peak resolution of 12-bits when using the on-chip PWM generator. The actual resolution of the PWM frequency depends upon on the ratio of the GSC frequency (typically provided by a systems HSYNC signal, but can

be internally generated) to the PHI frequency, because the on-time of a string is programmed as a 12-bit count of the number of GSC clock cycles. This count can be further scaled by an 8-bit Global intensity value, when enabled. The GSC clock is also used to precisely set each string's phase delay so that it is synchronized relative to the video frame.

The Efficiency Optimizers control a wide range of different architectures of external DC/DC and AC/DC converters. Multiple drivers in a system communicate with each other in real time to select an optimized operating voltage for the LEDs. This allows design of the power supply for the worst case Forward Voltage (V_f) of the LEDs without worrying about excessive power dissipation issues. During the start-up sequence the MSL3163/4 automatically reduce the power supply voltage to the minimum voltage required to keep the LEDs in current regulation. The devices can be configured to periodically perform this optimization to compensate for changes of the LED's forward voltage, and to assure continued optimum power savings.

Internal Regulators and Enable Input

The MSL3163/4 includes an internal linear regulator that operates from the 5V nominal input supply, VIN, and provides an internal 2.5V supply, VDD, to power the low-voltage internal circuitry. Bypass VDD (pin 36) to GND with a 4.7 μ F capacitor. Bypass VIN (pin 35) to GND with a 10 μ F capacitor.

The MSL3163/4 enable input, EN, enables the device. Drive EN low to enter low power operation, which lowers quiescent current draw to less than 20 μ A. With EN low the serial interface is ignored. Drive EN high to turn on the device. When EN is driven high the contents of the E²PROM are boot-loaded into the control registers, simulating a cold start-up.



Setting the LED String Current with R_{ILED} and ISTR

The MSL3163/4 features 16 current sink outputs, rated at 40V, each designed to sink up to 100mA peak. Limit average current to 60mA if the PCB copper around the MSL3163/4 is the only heat sink employed. The maximum string current, I_{ILED} , for all 16 LED string inputs is set by a single external resistor, R_{ILED} , placed from ILED to GND, whose value is determined using:

$$R_{ILED} = \frac{762}{I_{ILED}}$$

For example, a full-scale LED current of 60mA returns $R_{ILED} = 12.7k\Omega$. The current for all LED strings is reduced from its full-scale value with 8-bit resolution using ISTR, the String Current Control register 0x0F.

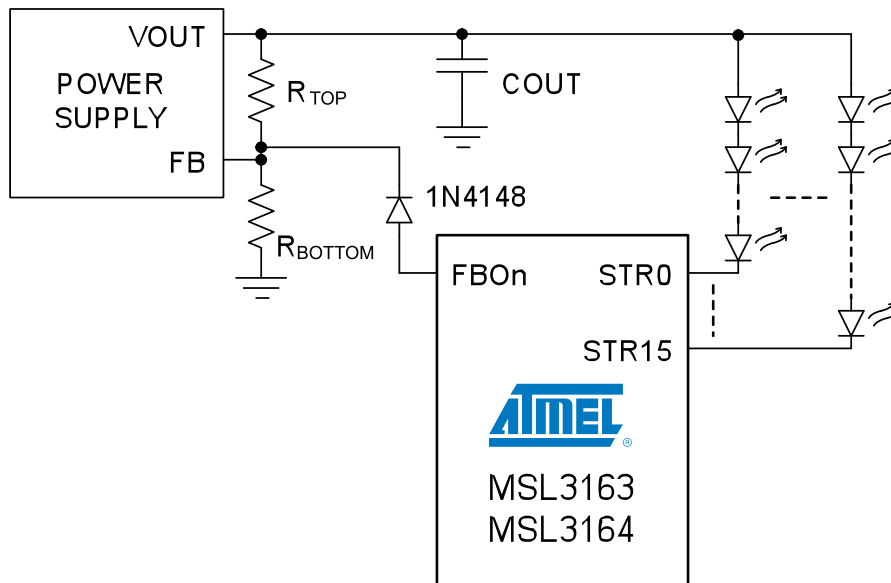


Figure 6. FBO connects to the Power Supply Voltage Divider Through a Diode

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Connecting the Efficiency Optimizer to an LED String Power Supply and Selecting Resistors

The MSL3163/4 are designed to control LED string power supplies that use a voltage divider (R_{TOP} and R_{BOTTOM} in Figure 6) to set output voltage, and whose regulation feedback voltage is not more than 3.5V. The Efficiency Optimizer improves power efficiency by injecting a current of between 0 μ A and 255 μ A into the voltage divider of the external power supply, dynamically adjusting the power supply's output to the minimum voltage required by the LED strings. To select the resistors first determine $V_{OUT(MIN)}$ and $V_{OUT(MAX)}$, the minimum and maximum string supply voltage limits, using:

$$V_{OUT(MIN)} = (V_{f(MIN)} * [\#ofLEDs]) + 0.5 ,$$

and

$$V_{OUT(MAX)} = (V_{f(MAX)} * [\#ofLEDs]) + 0.5 ,$$

where $V_{f(MIN)}$ and $V_{f(MAX)}$ are the LED's minimum and maximum forward voltage drops at the peak current set by R_{LED} (page 10). For example, if the LED data are $V_{f(MIN)} = 3.5V$ and $V_{f(MAX)} = 3.8V$, and ten LEDs are used in a string, then the total minimum and maximum voltage drops across the LEDs are 35V and 38V. Adding an allowance of 0.5V of for the string drive MOSFET headroom brings $V_{OUT(MIN)}$ to 35.5V and $V_{OUT(MAX)}$ to 38.5V. Do not to exceed the 40V maximum specification of the string drivers STR1 thru STR15. Then determine R_{TOP} using:

$$R_{TOP} = \frac{V_{OUT(MAX)} - V_{OUT(MIN)}}{I_{FBO n(MAX)}}$$

where $I_{FBO n(MAX)}$ is the 255 μ A maximum output current of the Efficiency Optimizer outputs FBO_n (if cascading multiple MSL3163/4s determine $I_{FBO n(MAX)}$ as shown in the next section). Finally, determine R_{BOTTOM} using:

$$R_{BOTTOM} = R_{TOP} * \frac{V_{FB}}{V_{OUT(MAX)} - V_{FB}}$$

where V_{FB} is the regulation feedback voltage of the power supply. Place a diode (1N4148 or similar) between FBO_n and the supply's feedback node to protect the MSL3163/4 against current flow into FBO_n.

Using Multiple Atmel LED Drivers-MSL3163/4s to Control a Common Power Supply

Cascade multiple MSL3163/4 devices into a chain configuration, with the FBO_n of one device connected to the FBO_n of the next (Figure 7). Connect the first FBO_n to the power supply feedback resistor node through a diode, and the unused FBO_n inputs (and any unused FBO_n outputs) to GND as close to the MSL3163/4 as possible. Assign all strings powered by a common supply to the proper FBO_n output using String Set registers (STR_nSET) 0x20 thru 0x3F. The chained devices work together to ensure that the system operates at optimum efficiency. Note that the accuracy of the feedback chain may degrade through each link of the FBO_n/FBO_n chain by as much as 2%. Determine the potential worst case maximum FBO_n current $I_{FBO n(MAX/MIN)}$ using:

$$I_{FBO n(MAX / MIN)} = 255\mu A * (0.98)^{N-1} ,$$

where N is the number of MSL3163/4s connected in series. Use this result in the above R_{TOP} resistor equation for the term $I_{FBO n(MAX)}$ instead of using 255 μ A.

Take care in laying out the traces for the Efficiency Optimizer connections. Minimize the FBO_n/FBO_n trace lengths as much as possible. Do not route the signals close to traces with large variations in voltage or current, because noise may couple into FBO_n. If these traces must be routed near noisy signals, shield them from noise by using ground planes or guard traces.

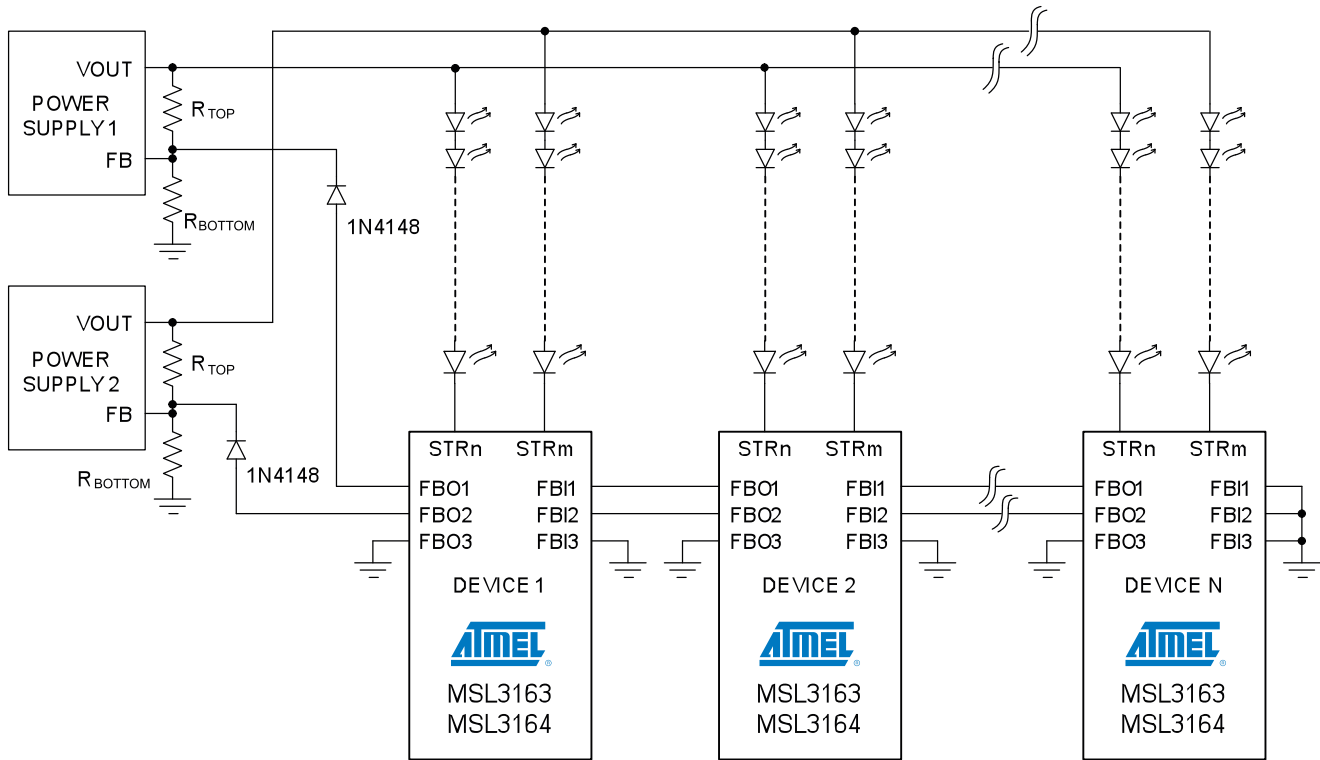


Figure 7. Example of Cascading Multiple Devices to Optimize Common Power Supplies

Direct PWM Control of the LED Strings

An external PWM signal applied to the PWM input allows direct PWM control over the strings when bits PWMEN and PWMDIRECT are set in PWM Control register 0x1E. This configuration bypasses PHI and GSC, but allows automatic LED string phase delay using bit D2 of register 0x1E.

The PWM input can also be configured as a gate for the output of the PWM engine using the PWM Global Enable bit D3 of the PWM Control register 0x1E.

Atmel LED Drivers-MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

Register Map and the E²PROM

Register Map Summary

Control the MSL3163/4 using the 96 registers in the range 0x00 thru 0x5F (Table 2). It may be convenient, and it is allowed, to read and write to unused bits in this range when accessing registers, but always write zeros. Reads from unused bits always return zeros. Three additional registers, 0x90, 0x91 and 0x93 allow access to the E²PROM and provide Efficiency Optimizer status. The power-up default values for all control registers are stored within the on-chip E²PROM, and any of these E²PROM values may be changed through the serial interface.

Table 2. Atmel LED Drivers-MSL3163/4 Register Map

| ADDRESS AND REGISTER NAME | | FUNCTION | REGISTER DATA | | | | | | | |
|---------------------------|-----------|--|---------------|----------------------|---------------|-------------|--------------|--------------|---------------|----------|
| | | | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0x00 | CONTROL0 | LED string enables | STR7EN | STR6EN | STR5EN | STR4EN | STR3EN | STR2EN | STR1EN | STR0EN |
| 0x01 | CONTROL1 | | STR15EN | STR14EN | STR13EN | STR12EN | STR11EN | STR10EN | STR9EN | STR8EN |
| 0x02 | POWERCTRL | Fault configuration | SLEEP | I ² CTOEN | PHIMINFEN | GSCMAXFEN | STRSCFEN | STROCFEN | FBOOCEN | FBOEN |
| 0x03 | FLTSTATUS | Fault status, global | - | - | PHIMINFLT | GSCMAXFLT | STRSCDET | STROCDDET | FBOOC | FLTDET |
| 0x04 | OCSTAT0 | String open circuit fault status | OC7 | OC6 | OC5 | OC4 | OC3 | OC2 | OC1 | OC0 |
| 0x05 | OCSTAT1 | | OC15 | OC14 | OC13 | OC12 | OC11 | OC10 | OC9 | OC8 |
| 0x06 | SCSTAT0 | String short circuit fault status | SC7 | SC6 | SC5 | SC4 | SC3 | SC2 | SC1 | SC0 |
| 0x07 | SCSTAT1 | | SC15 | SC14 | SC13 | SC12 | SC11 | SC10 | SC9 | SC8 |
| 0x08 | FLTMASK0 | String fault masks | FLTEN7 | FLTEN6 | FLTEN5 | FLTEN4 | FLTEN3 | FLTEN2 | FLTEN1 | FLTEN0 |
| 0x09 | FLTMASK1 | | FLTEN15 | FLTEN14 | FLTEN13 | FLTEN12 | FLTEN11 | FLTEN10 | FLTEN9 | FLTEN8 |
| 0x0A | FBOCTRL0 | Efficiency Optimizer control | HDRMSTEP[1:0] | | FBCLDLY[1:0] | | FBSLDLY[1:0] | | FBCFDLY[1:0] | |
| 0x0B | FBOCTRL1 | | SCCDLY[1:0] | | DECRSTEP[1:0] | | INITPWM | ACAL100 | ACALEN | ICCHKDIS |
| 0x0C | FBODAC1 | Efficiency Optimizer DAC readback | FBODAC1[7:0] | | | | | | | |
| 0x0D | FBODAC2 | | FBODAC2[7:0] | | | | | | | |
| 0x0E | FBODAC3 | | FBODAC3[7:0] | | | | | | | |
| 0x0F | ISTR | 8-bit global string current | ISTR[7:0] | | | | | | | |
| 0x10 | OSCCTRL | Oscillator frequency | - | - | - | - | - | OSCCTRL[2:0] | | |
| 0x11 | GSCCTRL | GSC processing control | GSCCHKSEL | - | - | - | GSCMAXEN | GSCPOL | GSCPHI-SYNCEN | GSCINTEN |
| 0x12 | GSCGEN | Internal GSC clock generator | GSCGEN[7:0] | | | | | | | |
| 0x13 | | | GSCGEN[15:8] | | | | | | | |
| 0x14 | GSCMUL | GSC multiplier | - | - | - | GSCMUL[4:0] | | | | |
| 0x15 | GSCDIV | GSC divider | - | - | - | - | GSCDIV[3:0] | | | |
| 0x16 | GSCMAX | Max oscillator cycles between GSC pulses | GSCMAX[7:0] | | | | | | | |
| 0x17 | | | GSCMAX[15:8] | | | | | | | |
| 0x18 | PHICTRL | PHI processing control | - | - | - | - | - | PHIMINEN | PHIPOL | PHIINTEN |
| 0x19 | PHIGEN | Internal PHI clock generator | PHIGEN[7:0] | | | | | | | |
| 0x1A | | | PHIGEN[15:8] | | | | | | | |



Table 2. Atmel LED Drivers-MSL3163/4 Register Map

| ADDRESS AND REGISTER NAME | | FUNCTION | REGISTER DATA | | | | | | | |
|--|-----------|---|---------------|-------------|--------|----------------|--------------|-------------|------------|------------|
| | | | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0x1B | | | UNUSED | | | | | | | |
| 0x1C | PHIMIN | Min GSC pulses over PHI period | PHIMIN[7:0] | | | | | | | |
| 0x1D | | | - | - | - | - | PHIMIN[11:8] | | | |
| 0x1E | PWMCTRL | PWM control | FLDBKEN | - | GINTEN | PWM-OFLOWEN | PWMGLBLEN | PHADLYEN | PWM-DIRECT | PWMEN |
| 0x1F | GINT | Global PWM scaling | GINT[7:0] | | | | | | | |
| 0x20 | STR0SET | Phase delay and EO assignment for string 0 | PHDLY0[7:0] | | | | | | | |
| 0x21 | | | COLSTR0[1:0] | - | - | PHDLY[11:8] | | | | |
| ↓ | ↓ | ↓ | ↓ | | | | | | | |
| 0x3E | STR15SET | Phase delay and EO assignment for string 15 | PHDLY15[7:0] | | | | | | | |
| 0x3F | | | COLSTR15[1:0] | - | - | PHDLY[11:8] | | | | |
| 0x40 | PWM0 | 12-bit PWM setting for string 0 | PWM0[7:0] | | | | | | | |
| 0x41 | | | - | - | - | - | PWM0[11:8] | | | |
| ↓ | ↓ | ↓ | ↓ | | | | | | | |
| 0x5E | PWM15 | 12-bit PWM setting for string 15 | PWM15[7:0] | | | | | | | |
| 0x5F | | | - | - | - | - | PWM15[11:8] | | | |
| - Do Not Access Address Range 0x60 Thru 0x8F - | | | | | | | | | | |
| 0x90 | E2ADDR | E ² PROM read/write access | - | E2ADDR[6:0] | | | | | | |
| 0x91 | E2CTRLSTA | | E2BUSY | BLDACT | E2ERR | - | - | RWCTRL[2:0] | | |
| 0x93 | FBOSTATUS | FBO status | FBOOPEN[3:1] | | | FBOACTIVE[3:1] | | | FBOCAL | FBOINITCAL |

Atmel LED Drivers-MSL3163 and MSL3164

16-string White & RGB LED Drivers with Adaptive Power Control, E²PROM, and SPI/I²C/SMBus Serial Interface

Register Power-Up Defaults

Register power-up default values are shown in Table 3

Table 3. Atmel LED Drivers-MSL3163/4 Register Power-Up Defaults

| REGISTER NAME AND ADDRESS | | POWER-UP CONDITION | REGISTER DATA | | | | | | | |
|---------------------------|-----------|--|---------------|----|----|----|----|----|----|----|
| | | | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0x00 | CONTROL0 | LED strings STR0 thru STR7 enabled | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0x01 | CONTROL1 | LED strings STR8 thru STR15 enabled | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0x02 | POWERCTRL | Efficiency Optimizer outputs enabled FBO open circuit detection enabled String open circuit detection enabled LED short circuit detection enabled GSC maximum fault detection disabled PHI minimum fault detection disabled I ² C bus timeout detection enabled Device awake | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| 0x08 | FLTMASK0 | Fault detection enabled on all strings | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0x09 | FLTMASK1 | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0x0A | FBOCTRL0 | Current sink error confirmation delay = 4μS FBO power supply correction delay = 2ms Efficiency Optimizer recalibration delay = 1s Efficiency Optimizer correction steps = 6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x0B | FBOCTRL1 | Current sink error detection not disabled Auto recalibration enabled PWM settings used during auto recalibration PWM duty cycle = 100% during initial calibration Efficiency Optimizer operates using 1μA steps LED short circuit confirmation delay = 4μs | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 |
| 0x0F | ISTR | Strings current set to 50% of R _{ILED} setting | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0x10 | OSCCTRL | f _{OSC} = 20MHz | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| 0x11 | GSCCTRL | GSC synchronized to the falling edge of the external signal | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x12 | GSCGEN | Although disabled, Internal GSC frequency = 20MHz / (19 + 1) = 1MHz | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 1 |
| 0x13 | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x14 | GSCMUL | GSC multiplied by 4 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| 0x15 | GSCDIV | GSC not divided | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x16 | GSCMAX | Although disabled, GSC max count is set to 19 clock cycles | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 1 |
| 0x17 | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x18 | PHICTRL | PHI synchronized to the falling edge of the external signal | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x19 | PHIGEN | Although disabled, Internal PHI frequency = 20MHz / (8 * (10416 + 1)) = 240Hz | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| 0x1A | | | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 |
| 0x1C | PHIMIN | No PHI minimum | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x1D | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |



| REGISTER NAME AND ADDRESS | | POWER-UP CONDITION | REGISTER DATA | | | | | | | |
|---------------------------|-----------|--|---------------|----|----|----|----|----|----|----|
| | | | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0x1E | PWMCTRL | PWM Operation enabled Internal PWM engine determines t_{ON} and t_{OFF} Phase delay enabled PWM input not eseed as gate for PWM engine output String on-times allowed to extend beyond PWM frame GINT ignored String current fold-back enabled | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 |
| 0x1F | GINT | Although Disabled, Global Intensity is set to $(127) / 256 = 49.6\%$ | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0x20 | STR0SET | All Strings set to 0 Phase Delay Strings Efficiency Optimizer assignments are: FBO1: Strings 0,4,8,12 FBO2: Strings 1,2,5,6,9,10,13,14 FBO3: Strings 3, 7, 11, 15 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x21 | | | 0* | 1* | 0 | 0 | 0 | 0 | 0 | 0 |
| ↓ | ↓ | | ↓ | | | | | | | |
| 0x3E | STR15SET | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x3F | | | 1* | 1* | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x40 | PWM0 | All Strings Have PWM Value = 512 GSC Cycles | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x41 | | | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| ↓ | ↓ | | ↓ | | | | | | | |
| 0x5E | PWM15 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x5F | | | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| 0x90 | E2ADDR | E ² PROM 7-bit address = 0x00 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x91 | E2CTRLSTA | E ² PROM read/write disabled | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x93 | FBOSTATUS | Feed Back Output Status | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

* These bits set the FBO on string assignments.

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